L Number	Hits	Search Text	DB	Time stamp
1	2	("4791634").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/24 14:12
2	0	jp-8227953$-$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/24 14:13
3	2	jp-08227953$-$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/24 14:13
6	21	zengerle.in. and heat	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/24 15:25
7	4	zengerle.in. and power adj semiconductor adj component	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/24 15:26
-	2	jp-09102568$-$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/24 13:32
-	2	jp-08227953$-$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/06 16:22
-	2	jp-08139479$-$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/06 16:24
-	3	("5785754").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/06 16:24
-	2008	((372/34) or (372/35) or (372/36)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 15:24
-	996	heat adj sink.ti. and 257/$6.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/07 07:45
-	33	heat adj sink.ti. and liquid.ti,ab. and 257/$6.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/21 15:28
-	20	(((((372/34) or (372/35) or (372/36)).CCLS.) or ((257/712) or (257/713) or (257/714 or (257/715)).CCLS.) and laser.ti,ab. and heat adj sink.ti,ab. and (liquid or water).ti,ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/21 08:27

-	9	(US-6307871-$ or US-5801442-$ or US-4791634-$ or US-4712019-$ or US-3764935-$).did. or (US-20010004370-$).did. or (JP-1225763-$ or JP-63073594-$).did.	USPAT; US-PGPUB; JPO	2002/08/07 15:49
-	388	(257/365).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/05 15:44
-	6068	(((372/34) or (372/35) or (372/36)).CCLS.) or (((257/712) or (257/713) or (257/714) or (257/715)).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/09 12:50
-	307	((((372/34) or (372/35) or (372/36)).CCLS.) or (((257/712) or (257/713) or (257/714) or (257/715)).CCLS.)) and heat adj sink and (liquid or water) near6 (cooler or coolant)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/09 12:52
-	110	(((((372/34) or (372/35) or (372/36)).CCLS.) or (((257/712) or (257/713) or (257/714) or (257/715)).CCLS.)) and heat adj sink and (liquid or water) near6 (cooler or coolant)) and (groove or slit or trench)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/09 12:53
-	63	((((((372/34) or (372/35) or (372/36)).CCLS.) or (((257/712) or (257/713) or (257/714) or (257/715)).CCLS.)) and heat adj sink and (liquid or water) near6 (cooler or coolant)) and (groove or slit or trench)) and (stack or (upper near12 lower))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/09 12:55
-	40	(((((((372/34) or (372/35) or (372/36)).CCLS.) or (((257/712) or (257/713) or (257/714) or (257/715)).CCLS.)) and heat adj sink and (liquid or water) near6 (cooler or coolant)) and (groove or slit or trench)) and (stack or (upper near12 lower))) and semiconductor	USPAT	2002/08/09 12:56
-	44	((((((((372/34) or (372/35) or (372/36)).CCLS.) or (((257/712) or (257/713) or (257/714) or (257/715)).CCLS.)) and heat adj sink and (liquid or water) near6 (cooler or coolant)) and (groove or slit or trench)) and (stack or (upper near12 lower))) and semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/09 13:32
-	1	heat adj sink.ti. and liquid.ti,ab. and 372/$6.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/21 15:29
-	33	heat adj sink.ti. and 372/$6.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/21 15:29
-	10026	heat adj sink and upper near12 lower	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 11:24
-	710	heat adj sink.ti. and upper near12 lower	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 11:25

–	70	heat adj sink.ti. and upper near12 lower near12 (face or main adj surface)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 11:26
–	30	heat adj sink.ti. and upper near6 lower adj (face or main adj surface)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 11:31
–	2	heat adj sink.ti. and (groove or trench) near12 upper near6 lower adj (face or main adj surface)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 11:33
–	2	heat adj sink.ti,ab. and (groove or trench) near12 upper near6 lower adj (face or main adj surface)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 11:34
–	2	heat adj sink.ti,ab. and (groove or trench) near18 upper near6 lower adj (face or main adj surface)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 11:35
–	4	heat adj sink.ti,ab. and (groove or trench) near18 upper near6 lower near6 (face or main adj surface)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 11:52
–	6	heat adj sink.ti,ab. and (groove or trench) near18 ((upper near18 lower) near18 (face or main adj surface))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 11:54
–	4163	((257/712) or (257/713) or (257/714) or (257/715)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 14:08
–	1156	(372/34).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 15:25
–	423	(372/35).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 15:25
–	661	(372/36).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 15:26
–	1884	(257/712).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 15:26
–	958	(257/713).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 15:26
–	1193	(257/714).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 15:26

-	493	257/715 .CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 15:16
-	6144	372/34 .CCLS. or 372/35 .CCLS. or 372/36 .CCLS. or 257/712 .CCLS. or ((257/713) .CCLS.) or ((257/714) .CCLS.) or ((257/715 .CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 15:17
-	4269	(((372/34).CCLS.) or ((372/35).CCLS.) or ((372/36).CCLS.) or ((257/712).CCLS.) or ((257/713).CCLS.) or ((257/714 .CCLS.) or ((257/715).CCLS.)) and (heat adj removal or heat adj sink or coolant or cooling)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 15:26
-	3590	(((372/34).CCLS.) or ((372/35).CCLS.) or ((372/36).CCLS.) or ((257/712).CCLS.) or ((257/713).CCLS.) or ((257/714).CCLS.) or ((257/715).CCLS.)) and (heat adj removal or heat adj sink or coolant or cooling).ti,ab,clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 15:29
-	1280	(((372/34).CCLS.) or ((372/35).CCLS.) or ((372/36).CCLS.) or ((257/712).CCLS.) or ((257/713).CCLS.) or ((257/714).CCLS.) or ((257/715).CCLS.)) and (heat adj removal or heat adj sink or coolant or cooling).ti,ab,clm. and liquid	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 15:29
-	263	(((372/34).CCLS.) or ((372/35).CCLS.) or ((372/36).CCLS.) or ((257/712).CCLS.) or ((257/713).CCLS.) or ((257/714).CCLS.) or ((257/715).CCLS.)) and (heat adj removal or heat adj sink or coolant or cooling).ti,ab,clm. and liquid and (groove or trench)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 15:30
-	27	(US-6198758-$ or US-6310900-$ or US-3654528-$ or US-4807022-$ or US-5729052-$ or US-5783862-$ or US-5864176-$ or US-5918665-$ or US-6157077-$ or US-6274912-$ or US-6347050-$ or US-5801442-$ or US-4712609-$ or US-3764935-$ or US-5241450-$ or US-4791634-$ or US-5812570-$ or US-6307871-$).did. or (US-20010004370-$).did. or (JP-02257683-$ or JP-63073584-$ or JP-09102568-$ or JP-08227953-$ or JP-08139479-$).did. or (JP-09102568-$ or EP-715352-$ or JP-08139479-$).did.	USPAT; US-PGPUB; JPO; DERWENT	2002/08/23 18:39
-	5	((US-6198758-$ or US-6310900-$ or US-3654528-$ or US-4807022-$ or US-5729052-$ or US-5783862-$ or US-5864176-$ or US-5918665-$ or US-6157077-$ or US-6274912-$ or US-6347050-$ or US-5801442-$ or US-4712609-$ or US-3764935-$ or US-5241450-$ or US-4791634-$ or US-5812570-$ or US-6307871-$).did. or (US-20010004370-$).did. or (JP-02257683-$ or JP-63073584-$ or JP-09102568-$ or JP-08227953-$ or JP-08139479-$).did. or (JP-09102568-$ or EP-715352-$ or JP-08139479-$).did.) and laser adj diode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 18:39